# Ultra-Low Power, Ultra Compact, AT Command / API Controlled, Sigfox<sup>®</sup> Verified Transceiver SiP for Up-Link and Down-Link



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#### **OVERVIEW**

#### **Circuit Description**

AX-SIP-SFEU and AX-SIP-SFEU-API are ultra-low power, ultra compact System-in-Package (SiP) solutions for a node on the Sigfox network with both up- and down-link functionality.

With a footprint of just 7 mm  $\times$  9 mm and conformal shielding, the AX–SIP–SFEU SiP, contains all the necessary components and firmware for transmit and receive operation on the European Sigfox network. No additional passive components or reference frequency providing parts are required on the customer's PCB. A single–ended 50  $\Omega$  antenna port is provided.

The AX-SIP-SFEU connects to the customer product using a logic level RS232 UART. AT commands are used to send frames and configure radio parameters.

The AX-SIP-SFEU-API variant is intended for customers wishing to write their own application software based on the AX-SIP-SF-LIB-1-GEVK library.

#### **Features**

Functionality and Ecosystem

- Single package, zero external components, full Sigfox up-link and down-link functionality controlled by AT commands or API
- The AX-SIP-SFEU and AX-SIP-SFEU-API SiPs are part of a whole development and product ecosystem available from ON Semiconductor for any Sigfox requirement. Other parts of the ecosystem include
  - Ready to go development kit
     DVK-SIP-SFEU-[API]-1-GEVK including
     a 2 year Sigfox subscription
- Sigfox® Verified

#### General Features

- SIP38 9 mm × 7 mm package
- Conformal shielding
- Supply range 2.1 V 3.6 V
- -30°C to 85°C
- Temperature sensor
- Supply voltage measurements

# • 15 GPIO pins

- 6 GPIO pins with selectable voltage measure functionality, differential (1 V or 10 V range) or single ended (1 V range) with 10 bit resolution
- 2 GPIO pins with selectable sigma delta DAC output functionality
- 2 GPIO pins with selectable output clock
- 3 GPIO pins selectable as SPI master interface
- Integrated RX/TX switching with single-ended 50 Ω antenna pin

#### Power Consumption

- Ultra-low Power Consumption:
  - Charge required to send a Sigfox OOB packet at nominal transmitter power (13 dBm typical at nominal temperature): 0.24 C
  - Deep Sleep mode current: 180 nA
  - Sleep mode current: 1.2 μA
  - Standby mode current: 0.55 mA

#### Features (Continued)

- Continuous radio RX-mode at 869.525 MHz: 14 mA
- ◆ Continuous radio TX-mode at 868.130 MHz: 45 mA @ nominal transmitter power (13 dBm)

High Performance Narrow-band Sigfox RF Transceiver

- Receiver
  - Carrier frequency 869.525 MHz
  - Data-rate 600 bps FSK
  - Sensitivity
    - -125 dBm @ 600 bps, 869.525 MHz, GFSK
  - 0 dBm maximum input power
- Transmitter
  - Carrier frequency 868.13 MHz
  - Data-rate 100 bps PSK
  - High efficiency, high linearity integrated power amplifier
  - Maximum output power 13 dBm
  - Power level programmable in 1 dBm steps

# **Applications**

• Sigfox networks up-link and down-link

#### **BLOCK DIAGRAM**

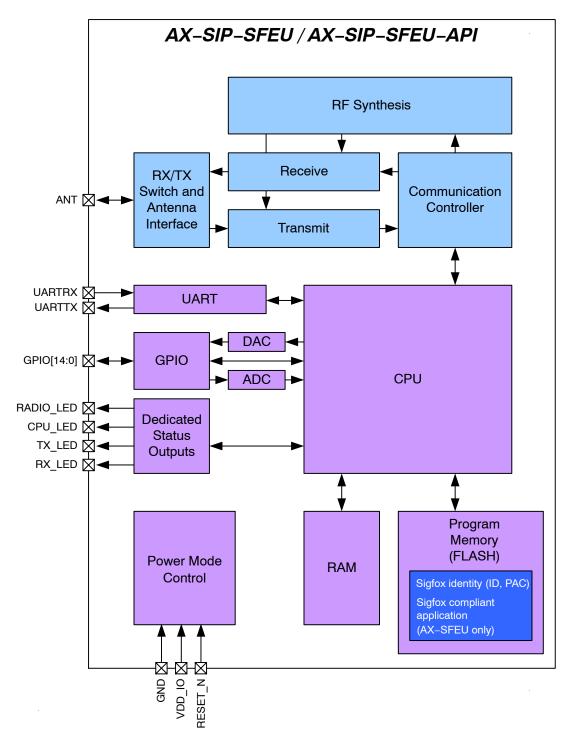


Figure 1. Functional Block Diagram of the AX-SIP-SFEU / AX-SIP-SFEU-API

**Table 1. PIN FUNCTION DESCRIPTIONS** 

Symbol	Pin(s)	Туре	Description	
GND	1	Р	Ground	
GND	2	Р	Ground	
ANT	3	Α	Single-ended 50 Ω antenna input/output	
GND	4	Р	Ground	
NC	5	N	Do not connect	
GND	6	Р	Ground	
NC	7	N	Do not connect	
NC	8	N	Do not connect	
NC	9	N	Do not connect	
GPIO11	10	I/O/PU	General purpose IO	
GPIO10	11	I/O/PU	General purpose IO	
GPIO8	12	I/O/PU	General purpose IO	
GPIO7	13	I/O/PU	General purpose IO, selectable SPI functionality (MISO)	
GPIO6	14	I/O/PU	General purpose IO, selectable SPI functionality (MOSI)	
GPIO5	15	I/O/PU	General purpose IO, selectable SPI functionality (SCK)	
GPIO4	16	I/O/PU	General purpose IO, selectable $\Sigma\Delta$ DAC functionality, selectable clock functionality	
CPU_LED	17	0	CPU activity indicator	
RADIO_LED	18	0	Radio activity indicator	
GPIO9	19	I/O/PU	General purpose IO, wakeup from deep sleep	
UARTTX	20	0	UART transmit	
UARTRX	21	I/PU	UART receive	
RX_LED/ DBG_DATA	22	O I/O	Receive activity indicator in AX–SIP–SFEU. Debugger data line in AX–SIP–SFEU–API.	
TX_LED/ DBG_CLK	23	0 	Transmit activity indicator in AX–SIP–SFEU. Debugger clock line in AX–SIP–SFEU–API.	
NC/ DBG_EN	24	PD PD	Do not connect in AX–SIP–SFEU. Debugger enable line in AX–SIP–SFEU–API.	
RESET_N	25	I/PU	Optional reset pin. Internal pull-up resistor is permanently enabled, nevertheless it is recommended to connect this pin to VDD_IO if it is not used.	
GND	26	Р	Ground	
VDD_IO	27	Р	Unregulated power supply	
GPIO0	28	I/O/A/PU	General purpose IO, selectable ADC functionality, selectable $\Sigma\Delta$ DAC functionality, selectable clock functionality	
GPIO1	29	I/O/A/PU	General purpose IO, selectable ADC functionality	
GPIO2	30	I/O/A/PU	General purpose IO, selectable ADC functionality	
NC	31	N	Do not connect	
NC	32	N	Do not connect	
GPIO3	33	I/O/A/PU	General purpose IO, selectable ADC functionality	
GPIO12	34	I/O/A/PU	General purpose IO, selectable ADC functionality	
GPIO13	35	I/O/A/PU	General purpose IO, selectable ADC functionality	
GPIO14	36	I/O/PU	General purpose IO	
NC	37	N	Do not connect	
NC	38	N	Do not connect	
GND	Center pads	Р	Ground on 6 center pads of SIP38, must be connected	

A = analog input or input/output

I = digital input signal

O = digital output signal

PU = pull-up

I/O = digital input/output signal

N = not to be connected

P = power or ground

PD = pull-down

All digital inputs are Schmitt trigger inputs, digital input and output levels are LVCMOS/LVTTL compatible. Pins GPIO[3:0] and GPIO[13:12] must not be driven above VDD\_IO, all other digital inputs are 5 V tolerant. All GPIO pins and UARTRX start up as input with pull-up. For explanations on how to use the GPIO pins, see chapter "AT Commands".

0 = pin drives low

1 = pin drives high

Z = pin is high impedance input

U = pin is input with pull-up

A = pin is analog input

T = pin is driven by clock or DAC

Table 2.

Pin	Possible GPIO Modes
GPIO0	0, 1, Z, U, A, T
GPIO1	0, 1, Z, U, A
GPIO2	0, 1, Z, U, A
GPIO3	0, 1, Z, U, A
GPIO4	0, 1, Z, U, T
GPIO5	0, 1, Z, U
GPIO6	0, 1, Z, U
GPIO7	0, 1, Z, U
GPIO8	0, 1, Z, U
GPIO9	0, 1, Z, U
GPIO10	0, 1, Z, U
GPIO11	0, 1, Z, U
GPIO12	0, 1, Z, U, A
GPIO13	0, 1, Z, U, A
GPIO14	0, 1, Z, U

## **Pinout Drawing**

Pins 22–24 have different functionalities in AT command and API versions, so for these pins AX–SIP–SFEU/AX–SIP–SFEU-API explanations are shown respectively.

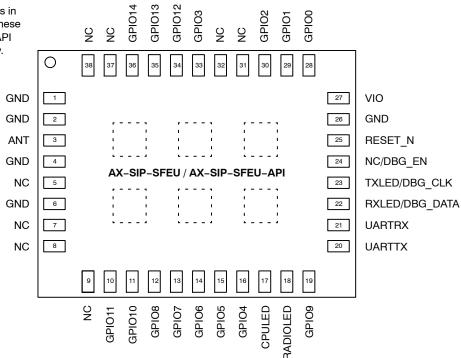


Figure 2. Pinout Drawing (Top View)

## **SPECIFICATIONS**

**Table 3. ABSOLUTE MAXIMUM RATINGS** 

Symbol	Description	Condition	Min	Max	Units
VDD_IO	Supply voltage		-0.5	3.8	V
IDD	Supply current			200	mA
P <sub>tot</sub>	Total power consumption			800	mW
Pi	Absolute maximum input power at receiver input	ANT pin in RX mode		10	dBm
I <sub>I1</sub>	DC current into any pin except ANT		-10	10	mA
I <sub>I2</sub>	DC current into pin ANT		-100	100	mA
Io	Output Current			40	mA
V <sub>ia</sub>	Input voltage ANT pin		-0.5	3.8	V
	Input voltage digital pins		-0.5	5.5	V
V <sub>es</sub>	Electrostatic handling	НВМ	-2000	2000	V
T <sub>amb</sub>	Operating temperature		-30	85	°C
T <sub>stg</sub>	T <sub>stg</sub> Storage temperature		-30	85	°C
Tj	Junction Temperature			150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## **DC Characteristics**

**Table 4. SUPPLIES** 

(Conditions for all current and charge values unless otherwise specified are for the DVK-SIP-SFEU-1-GEVK hardware configuration.)

Symbol	Description	Condition	Min	Тур	Max	Units
T <sub>AMB</sub>	Operational ambient temperature		-30	27	85	°C
VDD <sub>IO</sub>	I/O and voltage regulator supply voltage		2.1	3.0	3.6	V
VDD <sub>IO R1</sub>	I/O voltage ramp for reset activation (Note 2)	Ramp starts at VDD IO ≤ 0.1 V	0.1			V/ms
VDD <sub>IO R2</sub>	I/O voltage ramp for reset activation (Note 2)	Ramp starts at 0.1 V < VDD IO < 0.7 V	3.3			V/ms
I <sub>DS</sub>	Deep sleep mode current	AT\$P = 2		180		nA
I <sub>SLP</sub>	Sleep mode current	AT\$P = 1		1.2		μΑ
I <sub>STDBY</sub>	Standby mode current (Note 3)			0.55		mA
I <sub>RX_CONT</sub>	Current consumption continuous RX	AT\$SE		14		mA
Q <sub>SFX_OOB_14</sub>	Charge to send a Sigfox out of band message, nominal transmitter power (Note 4)	AT\$SO		0.24		С
Q <sub>SFX_BIT_14</sub>	Charge to send a bit, nominal transmitter power (Note 4)	AT\$SB = 0		0.16		С
Q <sub>SFX_BITDL_14</sub>	Charge to send a bit with downlink receive, nominal transmitter power (Note 4)	AT\$SB = 0,1		0.44		С
Q <sub>SFX_LFR_14</sub>	Charge to send the longest possible Sigfox frame (12 byte), nominal transmitter power (Note 4)	AT\$SF = 00112233445566778899aabb		0.29		С
Q <sub>SFX_LFRDL_14</sub>	Charge to send the longest possible Sigfox frame (12 byte) with downlink receive, nominal transmitter power (Note 4)	AT\$SF = 00112233445566778899aabb,1		0.57		С
I <sub>TXMOD14AVG</sub>	Modulated Transmitter Current (Note 5)	P <sub>out</sub> = 13 dBm; average		45		mA

If VDD\_IO ramps cannot be guaranteed, an external reset circuit is recommended, see the AX8052 Application Note: Power On Reset.
 20 MHz Fast RC oscillator, voltage conditioning and supervisory circuit running.

Power setting 14, which gives 13 dBm typical power at nominal temperature.
 Current consumption value is given for a matching network that is optimized for maximum power (setting 14, also nominal setting).

# **Typical Current Waveform**

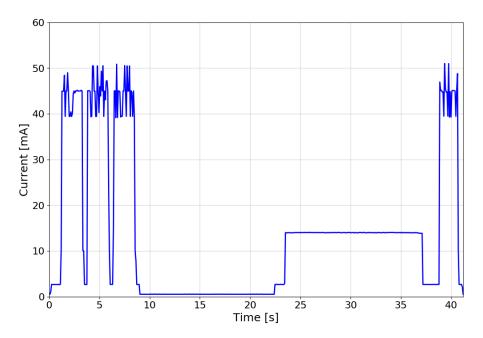


Figure 3. Typical Current Waveform for a Maximum Length Frame with Downlink Receive at Nominal Transmitter Power

## **Battery Life Example**

- 2 AAA Alkaline batteries in series
- One OOB frame transmitter per day at nominal transmitter power (P<sub>out</sub> = 13 dBm typical)
- Four maximum length frames with downlink receive per day at nominal transmitter power (P<sub>out</sub> = 13 dBm typical)
- Device in Sleep
- Neglecting battery self-discharge

2 AAA alkaline capacity	1500 mAh × 3600 s/h	5400 C
Sleep charge per day	1.2 μA × 86400 s	0.10 C/day
OOB frame transmission		0.24 C/day
Frame transmission with downlink	4 × 0.57 C/day	2.28 C/day
Total Charge consumption		2.62 C/day
Battery life		5.6 Years

Table 5. LOGIC

Symbol	Description	Condition	Min	Тур	Max	Units
DIGITAL IN	NPUTS	•	•			
V <sub>T+</sub>	Schmitt trigger low to high threshold point	VDD_IO = 3.3 V		1.55		V
V <sub>T-</sub>	Schmitt trigger high to low threshold point			1.25		V
V <sub>IL</sub>	Input voltage, low				0.8	V
V <sub>IH</sub>	Input voltage, high		2.0			V
V <sub>IPA</sub>	Input voltage range, GPIO[3:0] and GPIO[13:12]		-0.5		VDD_IO	V
V <sub>IPBC</sub>	Input voltage range, GPIO[9:4], UARTRX		-0.5		5.5	V
ΙL	Input leakage current		-10		10	μΑ
R <sub>PU</sub>	Programmable Pull-Up Resistance			65		kΩ
DIGITAL O	UTPUTS	•				
I <sub>OH</sub>	Output Current, high GPIO[14:0], UARTTX, TXLED, RXLED, TXLED, CPULED	V <sub>OH</sub> = 2.4 V	8			mA
l <sub>OL</sub>	Output Current, low GPIO[14:0], UARTTX, TXLED, RXLED, TXLED, CPULED	V <sub>OL</sub> = 0.4 V	8			mA
I <sub>OZ</sub>	Tri-state output leakage current		-10		10	μΑ

#### **AC Characteristics**

#### **Table 6. TRANSMITTER**

(Conditions for transmitter specifications unless otherwise specified are for DVK-SIP-SFEU-1-GVK hardware configuration and at 868.130 MHz frequency.)

Symbol	Description	Condition	Min	Тур	Max	Units
SBR	Signal bit rate			100		bps
PTX <sub>min</sub>	Lowest Transmitter output power (Note 6)	AT\$CW=868130000,1,0		-1		dBm
PTX <sub>max</sub>	Highest Transmitter output power (Note 6)	AT\$CW=868130000,1,14		13		dBm
PTX <sub>step</sub>	Programming step size output power			1		dB
dTX <sub>temp</sub>	Transmitter power variation vs. temperature	-30°C to +85°C		±0.8		dB
dTX <sub>Vdd</sub>	Transmitter power variation vs. VDD_IO	2.1 to 3.6 V		±0.03		dB
PTX <sub>harm2</sub>	Emission @ 2 <sup>nd</sup> harmonic			-58		dBc
PTX <sub>harm3</sub>	Emission @ 3 <sup>rd</sup> harmonic			-80		
PTX <sub>harm4</sub>	Emission @ 4 <sup>th</sup> harmonic			-86		

<sup>6.</sup> The output power of the AX-SIP-SFEU / AX-SIP-SFEU-API can be programmed in 1 dB steps, by changing transmitter power setting from 0 – 14. The lowest power setting is 0, which gives –1 dBm typical power at nominal temperature. The highest power setting is 14, which gives 13 dBm typical power at nominal temperature and close to 14 dBm typical power at minimum temperature.

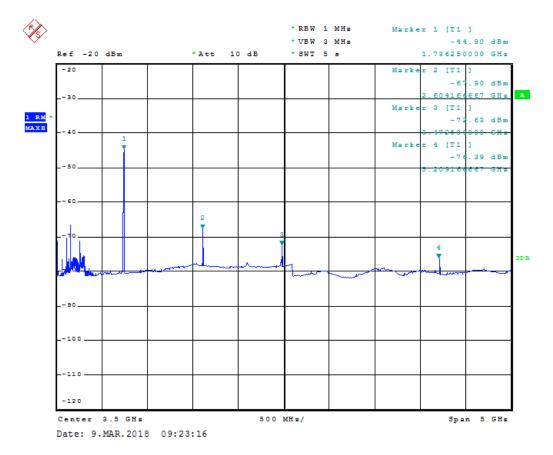


Figure 4. Typical Spectrum with Harmonics at Nominal Output Power

# Table 7. RECEIVER

(Conditions for receiver specifications unless otherwise specified are for DVK-SIP-SFEU-1-GEVK hardware configuration and at 869.525 MHz frequency.)

Symbol	Description	Condition	Min	Тур	Max	Units
SBR	Signal bit rate			600		bps
ISBER868	Sensitivity	Evaluated at BER > 10 <sup>-3</sup> . AT command used: AT\$PN=4,5		-125		dBm
BLK <sub>2M-868</sub>	Blocking level at ±2 MHz offset	Evaluated at BER > 10 <sup>-3</sup> . Wanted signal is +3 dB above the typical sensitivity, the blocker signal is CW. AT command used: AT\$PN=4,5.		-53		dBm
BLK <sub>10M-868</sub>	Blocking level at ±10 MHz offset	Evaluated at BER > 10 <sup>-3</sup> . Wanted signal is +3 dB above the typical sensitivity, the blocker signal is CW. AT command used: AT\$PN=4,5.		-32		dBm

**Table 8. ADC/TEMPERATURE SENSOR** 

Symbol	Description	Condition	Min	Тур	Max	Units
ADCRES	ADC resolution			10		Bits
V <sub>ADCREF</sub>	ADC reference voltage		0.95	1	1.05	٧
Z <sub>ADC00</sub>	Input capacitance				2.5	pF
DNL	Differential nonlinearity			±1		LSB
INL	Integral nonlinearity			±1		LSB
OFF	Offset			3		LSB
GAIN_ERR	Gain error			0.8		%
ADC IN DIFFERENTIAL MODE						•
V <sub>ABS_DIFF</sub>	Absolute voltages & common mode voltage in differential mode at each input		0		VDD_IO	V
V <sub>FS_DIFF01</sub>	Full swing input for differential signals	Gain ×1	-500		500	mV
V <sub>FS_DIFF10</sub>		Gain ×10	-50		50	mV
ADC IN SIN	IGLE ENDED MODE		•			
V <sub>MID_SE</sub>	Mid code input voltage in single ended mode			0.5		V
V <sub>IN_SE00</sub>	Input voltage in single ended mode		0		VDD_IO	V
V <sub>FS_SE01</sub>	Full swing input for single ended signals	Gain ×1	0		1	٧
TEMPERAT	TURE SENSOR		•	•	•	•
T <sub>RNG</sub>	Temperature range	AT\$T?	-30		85	°C

# **COMMAND INTERFACE**

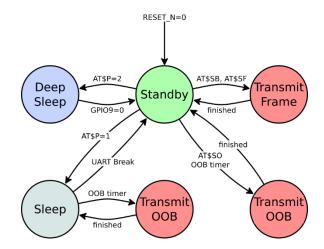
#### **General Information**

The chapter "Command Interface" is a documentation of the AT-Command set for devices which do not have an API-interface. To see whether the device is capable of receiving AT-Commands, please refer to the table "Device Versions". If the device has been shipped with the API-Interface, please refer to the SW manual and "apiexample" code delivered with AX-SIP-SF-LIB-1-GEVK for an introduction on how to setup a project and how to use the API-Interface.

# Serial Parameters: 9600, 8, N, 1

The AX-SIP-SFEU uses the UART (pins UARTTX, UARTRX) to communicate with a host and uses a bitrate of **9600 baud**, no parity, 8 data bits and one stop bit.

#### **Power Modes**



#### Standby

After Power–Up and after finishing a Sigfox transmission, AX–SIP–SFEU enters Standby mode. In Standby mode, AX–SIP–SFEU listens on the UART for commands from the host. Also, OOB frames are transmitted whenever the OOB timer fires. To conserve power, the AX–SIP–SFEU can be put into Sleep or turned off (Deep Sleep) completely.

#### Sleep

The command AT\$P=1 is used to put the AX-SIP-SFEU into Sleep mode. In this mode, only the wakeup timer for out-of-band messages is still running. To wake the AX-SIP-SFEU up from Sleep mode toggle the serial UARTRX pin, e.g. by sending a break (break is an RS232 framing violation, i.e. at least 10 bit durations low). When an Out of Band (OOB) message is due, AX-SIP-SFEU automatically wakes up to transmit the message, and then returns to Sleep mode.

## Deep Sleep

In Deep Sleep mode, the AX-SIP-SFEU is completely turned off and only draws negligible leakage current.

Deep Sleep mode can be activated with AT\$P=2. To wake-up from Deep Sleep mode, GPIO9 is pulled to GND.

When using Deep Sleep mode, keep two things in mind: Everything is turned off, timers are not running at all and all settings will be lost (use **AT\$WR** to save settings to flash before entering Deep Sleep mode). Out-of-band messages will therefore not be sent. The pins states are frozen in Deep Sleep mode. The user must ensure that this will not result in condition which would draw a lot of current.

#### **AT Commands**

#### Numerical Syntax

```
hexdigit ::= [0-9A-Fa-f]
Hexnum ::= "0x" hexdigit+
decnum ::= "0" | [1-9] [0-9]*
octnum ::= "0" [0-7]+
binnum ::= "0b" [01]+
bit ::= [01]
optnum ::= "-1"
Frame ::= (hexdigit hexdigit)+
uint ::= hexnum | decnum | octnum | binnum
uint_opt ::= uint | optnum
```

#### Command Syntax

A command starts with 'AT' (everything is case sensitive!), continues with the actual command followed by parameters (if any) and ends with any kind of whitespace (space, tab, newline etc.)

If incorrect syntax is detected ("parsing error") all input is ignored up until the next whitespace character.

Also note that any number can be entered in any format (Hexadecimal, Decimal, Octal and binary) by adding the corresponding prefix ('0x', '0', '0b'). The only exception is the 'Send Frame' command (AT\$SF) which expects a list of hexadecimal digits without any prefix.

#### Return Codes

A successful command execution is indicated by sending 'OK'. If a command returns a value (e.g. by querying a register) only the value is returned.

#### Examples

Bold text is sent to AX-SIP-SFEU.

#### AT\$I=0

AX-SF 1.1-RC1

Here, we execute command 'I' to query some general information.

#### AT\$SF=aabb1234

OK

This sends a Sigfox frame containing  $\{0xAA : 0xBB : 0x12 : 0x34\}$  without waiting for a response telegram.

#### AT\$SF=0011223344,1

OK

RX=AA BB CC DD

This sends a Sigfox frame containing  $\{0x00 : 0x11 : 0x22 : 0x33 : 0x44\}$ , then waits for a downlink response telegram, which in this example contains  $\{0xAA : 0xBB : 0xCC : 0xDD\}$ .

#### AT\$CB=0xAA,1

OK

The 'CB' command sends out a continuous pattern of bits, in this case 0xAA = 0b10101010.

## AT\$P=1

OK

This transitions the device into sleep mode. Out-of-band transmissions will still be triggered. The UART is powered down. The device can be woken up by a low level on the UART signal, i.e. by sending break.

## **Table 9. COMMANDS**

Command	Name		Des	scription		
AT	Dummy Command	Just returns 'communication		g else. Can be used to check		
AT\$SB=bit[,bit]	Send Bit	Send a bit sta should receiv	atus (0 or 1). Optiona re a downlink frame.	al bit flag indicates if AX-SIP-SFEU		
AT\$SF=frame[,bit]	Send Frame	Send payload data, 1 to 12 bytes. Optional bit flag indicates if AX–SIP–SFEU should receive a downlink frame.				
AT\$SO	Manually send out of band message	Send the out-	of-band message.			
AT\$TR?	Get the transmit repeat	Returns the n	number of transmit re	epeats. Default: 2		
AT\$TR=?	Get transmit repeat range	Returns the a	allowed range of tran	smit repeats.		
AT\$TR=uint	Set transmit repeat	Sets the trans	smit repeat, sets onl	y for transmit with downlink frame.		
ATSuint?	Get Register	Query a spector a list of re-		gister's value. See Table 10 "Registers"		
ATSuint=int	Set Register	Change a cor	nfiguration register.			
ATSuint=?	Get Register Range	Returns the a	allowed range of the	register values.		
AT\$IF=uint	Set TX Frequency	Set the output	ıt carrier macro chan	nnel for Sigfox frames.		
AT\$IF?	Get TX Frequency	Get the curre	ntly chosen TX frequ	uency.		
AT\$DR=uint	Set RX Frequency	Set the recep	otion carrier macro cl	hannel for Sigfox frames.		
AT\$DR?	Get RX Frequency	Get the curre	ntly chosen RX frequ	uency.		
AT\$CW=uint,bit[,uint_opt]	Continuous Wave	To run emission tests for Sigfox certification it is necessary to send a continuous wave, i.e. just the base frequency without any modulation. Parameters:				
		Name	Range	Description		
		Frequency	80000000- 99999999, 0	Continuous wave frequency in Hz. Use 868130000 for Sigfox or 0 to keep previous frequency.		
		Mode	0, 1	Enable or disable carrier wave.		
		Power	0-14	Signal power setting   Default: 14		
AT\$CB=uint_opt,bit	Test Mode: TX constant byte	3 1 31				
		Name	Range	Description		
		Pattern	0–255, –1	Byte to send. Use '-1' for a (pseudo-)random pattern.		
		Mode	0, 1	Enable or disable pattern test mode.		
AT\$T?	Get Temperature	Measure internal temperature and return it in 1/10th of a degree Celsius.				
AT\$V?	Get Voltages	Return currer transmission		e measured during the last		

Table 9. COMMANDS (continued)

Command	Name	Description
AT\$I=uint	Information	Display various product information:  0: Software Name & Version     Example Response: AX-SF 1.1-RC1  1: Contact Details     Example Response: onhelp@onsemi.com  2: Silicon revision lower byte     Example Response: 90  3: Silicon revision upper byte     Example Response: 51  4: Major Firmware Version     Example Response: 1  5: Minor Firmware Version     Example Response: 1  7: Firmware Variant (Frequency Band etc. (EU/US))     Example Response: RC1  8: Firmware VCS Version     Example Response: 0  9: Sigfox Library Version     Example Response: UDL1-1.8.9  10: Device ID     Example Response: 00012345  11: PAC     Example Response: 0123456789ABCDEF
AT\$P=uint	Set Power Mode	To conserve power, the AX–SIP–SFEU can be put to sleep manually. Depending on power mode, you will be responsible for waking up the AX–SIP–SFEU again!  0: software reset (settings will be reset to values in flash)  1: sleep (send a break to wake up)  2: deep sleep (toggle GPIO9 or RESET_N pin to wake up; the AX–SIP–SFEU is not running and all settings will be reset!)
AT\$WR	Save Config	Write all settings to flash (RX/TX frequencies, registers) so they survive reset/deep sleep or loss of power. Use AT\$P=0 to reset the AX-SIP-SFEU and load settings from flash.
AT:Pn?	Get GPIO Pin	Return the setting of the GPIO Pin n; n can range from 0 to 14.  A character string is returned describing the mode of the pin, followed by the actual value. If the pin is configured as analog pin, then the voltage (range 01 V) is returned. The mode characters have the following meaning:  Mode  Description  0 Pin drives low 1 Pin drives high Z Pin is high impedance input U Pin is input with pull-up A Pin is analog input (GPIO pin 03 and 1213 only) T Pin is driven by clock or DAC (GPIO pin 0 and 4 only) The default mode after exiting reset is U on all GPIO pins.

Table 9. COMMANDS (continued)

Command	Name	Description
AT:Pn=?	Get GPIO Pin Range	Print a list of possible modes for a pin. The table below lists the response.  Pin Modes P0 0, 1, Z, U, A, T P1 0, 1, Z, U, A P2 0, 1, Z, U, A P3 0, 1, Z, U, A P4 0, 1, Z, U, T P5 0, 1, Z, U P6 0, 1, Z, U P7 0, 1, Z, U P8 0, 1, Z, U P9 0, 1, Z, U P9 0, 1, Z, U P10 0, 1, Z, U P11 0, 1, Z, U P12 0, 1, Z, U P12 0, 1, Z, U P13 0, 1, Z, U, A P13 0, 1, Z, U, A P14 0, 1, Z, U
AT:Pn=mode	Set GPIO Pin	Set the GPIO pin mode. For a list of the modes see the command AT:Pn?
AT:ADC Pn[-Pn[ (1V 10V)]]?	Get GPIO Pin Analog Voltage	Measure the voltage applied to a GPIO pin. The command also allows measurement of the voltage difference across two GPIO pins. In differential mode, the full scale range may also be specified as 1 V or 10 V. Note however that the pin input voltages must not exceed the range 0VDD_IO. The command returns the result as fraction of the full scale range (1 V if none is specified). The GPIO pins referenced should be initialized to analog mode before issuing this command.
AT:SPI[(A B C D)]=bytes	SPI Transaction	This command clocks out <i>bytes</i> on the SPI port. The clock frequency is 312.5 kHz. The command returns the bytes read on MISO during output. Optionally the clocking mode may be specified (default is A):  Mode  Clock Inversion  Clock Phase  A normal  B normal alternate  C inverted normal  D inverted alternate  SEL(GPIOx)  MOSI  D7 D6 D5 D4 D3 D2 D1 D0  MISO  D7 D6 D5 D4 D3 D2 D1 D0  SCK  C  D  Note that SEL, if needed, is not generated by this command, and must instead be driven using standard GPIO commands (AT:Pn=0 1).
AT:CLK=freq,reffreq	Set Clock Generator	Output a square wave on the pin(s) set to T mode. The frequency of the square wave is (freq / $2^{16}$ ) × reffreq. Possible values for reffreq are 20000000, 10000000, 5000000, 2500000, 1250000, 625000, 312500, 156250. Possible values for freq are 065535.
AT:CLK=OFF	Turn off Clock Generator	Switch off the clock generator
AT:CLK?	Get Clock Generator	Return the settings of the clock generator. Two numbers are returned, freq and reffreq.
AT:DAC=value	Set ΣΔ DAC	Output a $\Sigma\Delta$ DAC value on the pin(s) set to T mode. Parameter value may be in the range –3276832767. The average output voltage is $(1/2 + \text{value} / 2^{17}) \times \text{VDD}$ . An external low pass filter is needed to get smooth output voltages. The modulation frequency is 20 MHz. A possible low pass filter choice is a simple RC low pass filter with R = 10 k $\Omega$ and C = 1 $\mu$ F.

Table 9. COMMANDS (continued)

Command	Name	Description		
AT:DAC=OFF	Turn off $\Sigma\Delta$ DAC	Switch off the DAC		
AT:DAC?	Get ΣΔ DAC	Return the DAC value		
AT\$TM=mode,config	Activates the Sigfox Testmode	<ul> <li>Available test modes:</li> <li>TX BPSK Send only BPSK with Synchro Bit + Synchro frame + PN sequence: No hopping centered on the TX_frequency. Config bits 0 to 6 define the number of repetitions. Bit 7 of config defines if a delay is applied or not between the frames in the loop (1 means no delay).</li> <li>TX Protocol: Tx mode with full protocol with Sigfox key: Send Sigfox protocol frames with initiate downlink flag = True. Config defines the number of repetitions.</li> <li>RX Protocol: This mode tests the complete downlink protocol in Downlink only. Config defines the RX on time in seconds.</li> <li>RX GFSK: RX mode with known pattern with SB + SF + Pattern on RX_frequency (internal comparison with received frame ⇔ known pattern = AA AA B2 27 1F 20 41 84 32 68 C5 BA AE 79 E7 F6 DD 9B. Config defines the number of repetitions.</li> <li>RX Sensitivity: Does uplink + downlink frame with Sigfox key and specific timings. This test is specific to Sigfox's test equipment &amp; software.</li> <li>TX Synthesis: Does one uplink frame on each Sigfox channel to measure frequency synthesis step.</li> </ul>		
AT\$SE	Starts AT\$TM=3,255 indefinitely	Convenience command for sensitivity tests		
AT\$SL[=frame]	Send local loop	Sends a local loop frame with optional payload of 1 to 12 bytes. Default payload: 0x84, 0x32, 0x68, 0xC5, 0xBA, 0x53, 0xAE, 0x79, 0xE7, 0xF6, 0xDD, 0x9B.		
AT\$RL	Receive local loop	Starts listening for a local loop.		
AT\$TP=repetitions	Transient power measurements mode	Used for transmitter transient power measurements. The command switches the transmitter ON and OFF. During ON state (pseudo) random bit pattern is send. Repetitions is the number of performed measurements, acceptable range is 1–255.		
AT\$PN=mode,repetitions	Send & Receive PN9 bitstream for BER measurements	Available modes:  0: send PN9 bit stream. Repetitions = 1 is required to start sending. Repetitions = 0 stops sending  3: receive PN9 bit stream, calculate BER with 3 digits precision  4: receive PN9 bit stream, calculate BER with 4 digits precision  5: receive PN9 bit stream, calculate BER with 5 digits precision  Mode = 3-5 receives the PN9 bitstream and decodes it into an actual BER measurement. Reports the BER for each repetition.  Repetitions is the number of performed measurements, acceptable range is 1-255. Higher precision result takes longer time to compute.  PN9 is 9-bit pseudo random binary sequence.		

Table 10. REGISTERS

Number	Name	Description	Default	Range	Units
300	Out Of Band Period	AX-SIP-SFEU sends periodic static messages to indicate that it is alive. Set to 0 to disable.	24	0–24	hours
302	Power Level	The output power of the radio. Note: this setting is used for all TX modes except AT\$CW.	14	0–14	0: –1dBm 14: 13 dBm
410	Encryption Key Configuration	Set to zero for normal operation. Set to one for use with the Sigfox Network Emulator Kit (SNEK).	0	0–1	0: private key 1: public key
411	Specific ID and Key for certification	Set to zero for use of regular device ID and key. Set to one to use specific ID and key for test sample devices for Sigfox certification.	0	0–1	0: regular sample 1: test sample
500	RSSI Offset	RSSI offset value can be applied to fine tune the RSSI level that the device reports.	0	-128127	dB

#### APPLICATION INFORMATION

#### **Typical Application Diagrams**

Typical AX-SIP-SFEU / AX-SIP-SFEU-API Application Diagram

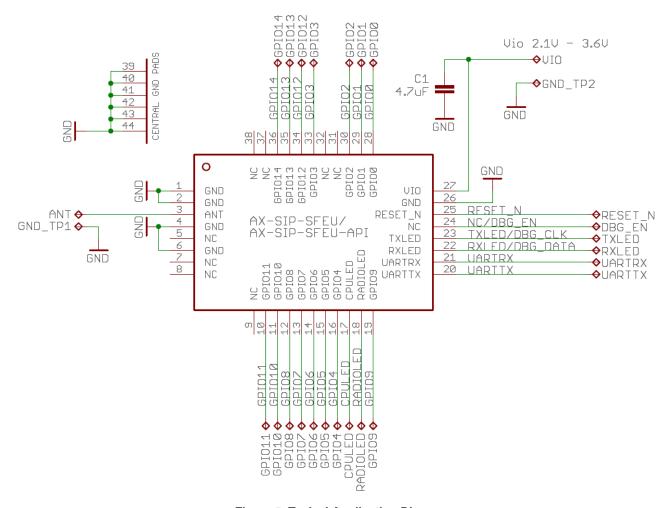
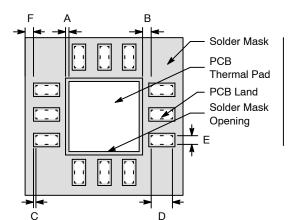


Figure 5. Typical Application Diagram

#### SIP38 RECOMMENDED PAD LAYOUT

1. PCB land and solder masking recommendations are shown in Figure 6.



- A = Clearance from PCB thermal pad to solder mask opening, 0.0635 mm
- B = Clearance from edge of PCB thermal pad to PCB land, 0.2 mm minimum
- C = Clearance from PCB land edge to solder mask opening to be as tight as possible to ensure that some solder mask remains between PCB pads
- D = PCB land length = SIP solder pad length + 0.1 mm
- E = PCB land width = SIP solder pad width + 0.1 mm
- F = Clearance from solder mask opening to the edge of the package, 0.1 mm minimum to avoid shorts to the package metal shielding

Figure 6. PCB Land and Solder Mask Recommendations

- 2. Thermal vias should be used around the PCB thermal pads (middle ground pads) to improve thermal conductivity from the device to a copper ground plane area on the reverse side of the printed circuit board. The number of vias depends on the package thermal requirements, as determined by thermal simulation or actual testing.
- 3. Increasing the number of vias through the printed circuit board will improve the thermal conductivity to the reverse side ground plane and external heat sink. In general, adding more metal through the PC board under the SiP will improve operational heat transfer, but will require careful attention to uniform heating of the board during assembly.

#### **Assembly Process**

Stencil Design & Solder Paste Application

1. Stainless steel stencils are recommended for solder paste application.

- 2. A stencil thickness of 0.125–0.150 mm (5–6 mils) is recommended for screening.
- 3. For the PCB thermal pads, solder paste should be printed on the PCB by designing a stencil with an array of 6 openings for each of the 6 thermal/GND pads.
- 4. The aperture opening for the signal pads should be between 50–80% of the SIP pad area as shown in Figure 7.
- 5. Optionally, for better solder paste release, the aperture walls should be trapezoidal and the corners rounded.
- 6. The fine pitch of the SiP leads requires accurate alignment of the stencil and the printed circuit board. The stencil and printed circuit assembly should be aligned to within + 1 mil prior to application of the solder paste.
- 7. No-clean flux is recommended since flux from underneath the thermal pad will be difficult to clean if water-soluble flux is used.

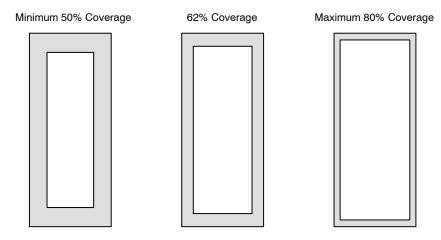


Figure 7. Solder Paste Application on Pins

## **Life Support Applications**

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## **Device Information**

The following device information can be queried using the AT-Commands AT\$I=4, AT\$I=5 for the APP version and AT\$I=2, AT\$I=3 for the chip version.

**Table 11. DEVICE VERSIONS** 

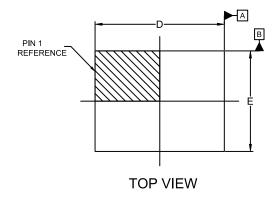
		APP Version		SiP Version	
Product	Part Number	[0]	[1]	[0]	[1]
AX-SIP-SFEU	AX-SIP-SFEU-1-01-TX30	0x01	0x01	0x90	0x51
AX-SIP-SFEU-API	AX-SIP-SFEU-API-1-01-TX30	0x01	0x01	0x90	0x51

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**DATE 14 MAR 2018** 



#### NOTES:

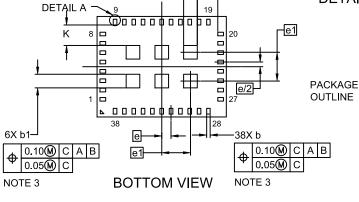
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSION b and b1 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
- 4. COPLANARITY APPLIES TO THE EXPOSED PADS AS WELL AS THE TERMINALS.



**DETAIL B** 



MILLIMETERS			
MIN.	NOM.	MAX.	
_	_	0.996	
		0.05	
	0.70	0.73	
	0.24	0.28	
0.20	0.25	0.30	
0.90	0.95	1.00	
8.90	9.00	9.10	
6.90	7.00	7.10	
0.65 BSC			
2.00 BSC			
1.42 REF			
0.55	0.60	0.65	
0.20 REF			
	MIN	MIN. NOM 0.70 0.24 0.20 0.25 0.90 0.95 8.90 9.00 6.90 7.00 0.65 BSC 2.00 BSC 1.42 REF 0.55 0.60	

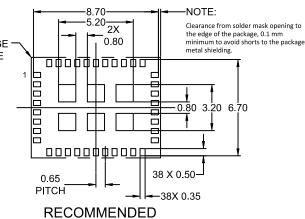


DETAIL B

SIDE VIEW

6X b1

0.10 C



MOUNTING FOOTPRINT

.

PLANE

AWLWLYYWW

A = Assembly Location

**GENERIC** 

**MARKING DIAGRAM\*** 

XXXXXXXXXX

XXXXXXXXXX

WL = Wafer Lot

YY = Year

WW = Work Week

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present. Some products may not follow the Generic Marking.

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